

Applicant Information

Applicant Authority Type::	Inventor
Applicant One Given Name::	Ai-Sen
Family Name::	Liu
Country::	Taiwan, R.O.C.

Correspondence Information

Correspondence Customer Number::27683

Application Information

Title Line One::	METHOD FOR FORMING DIELECTRIC BARRIER
Title Line Two::	LAYER IN DAMASCENE STRUCTURE
Total Drawing Sheets::	7
Formal Drawings?::	No
Application Type::	Utility
Docket Number::	24061.142
Secrecy Order in Parent Appl?::	No

Representative Information

Registration Number::	42,044
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Assignee Information

Assignee Name::	Taiwan Semiconductor Manufacturing Company, Ltd.
Street of mailing address::	No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park
City::	Hsin-Chu
Country of mailing address::	Taiwan, R.O.C.
Postal or Zip Code::	300-77